

N-Channel Enhancement Mode MOSFET

TDM31518

DESCRIPTION

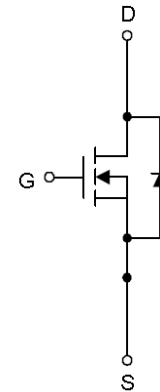
The TDM31518 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

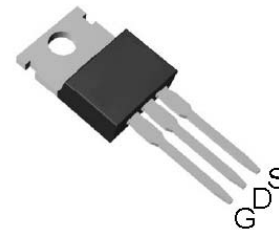
- RDS(ON) < 13.5mΩ @ VGS=10V
- Reliable and Rugged
- Lead free product is available
- TO-220 Package

Application

- PWM applications
- Load switch
- Power management



N-Channel MOSFET



Top View of TO-220

ABSOLUTE MAXIMUM RATINGS($T_A=25^{\circ}C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|--|-------|------|
| Drain-Source Voltage | V _{DS} | 150 | V |
| Gate-Source Voltage | V _{GS} | ±30 | V |
| Diode Continuous Forward Current | I _S (T _C =25°C) | 80 | A |
| Drain Current @ Continuous | I _D (T _C =25°C) | 86 | A |
| | I _D (T _C =100°C) | 54 | A |
| Drain Current @ Current-Pulsed (Note 1) | I _{DM} (T _C =25°C) | 300 | A |
| Maximum Power Dissipation | P _D (T _C =25°C) | 250 | W |
| | P _D (T _C =100°C) | 100 | W |
| Drain Current @ Continuous | I _D (T _A =25°C) | 8 | A |
| | I _D (T _A =70°C) | 6 | A |
| Maximum Power Dissipation (T _A =25°C) | P _D (T _A =25°C) | 2 | W |
| | P _D (T _A =70°C) | 1.25 | W |
| Avalanche Energy, Single pulse(L=0.5mH) | E _{AS} | 240 | mJ |

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THERMAL CHARACTERISTICS

| | | | |
|---|--------------------------------|------------|---------------|
| Thermal Resistance-Junction to Case | $R_{\theta JC}$ (Steady State) | 0.5 | $^{\circ}C/W$ |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ (Steady State) | 62.5 | $^{\circ}C/W$ |
| Maximum Operating Junction Temperature | T_J | 150 | $^{\circ}C$ |
| Storage Temperature Range | T_{STG} | -55 To 150 | $^{\circ}C$ |

ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}C$ unless otherwise noted)

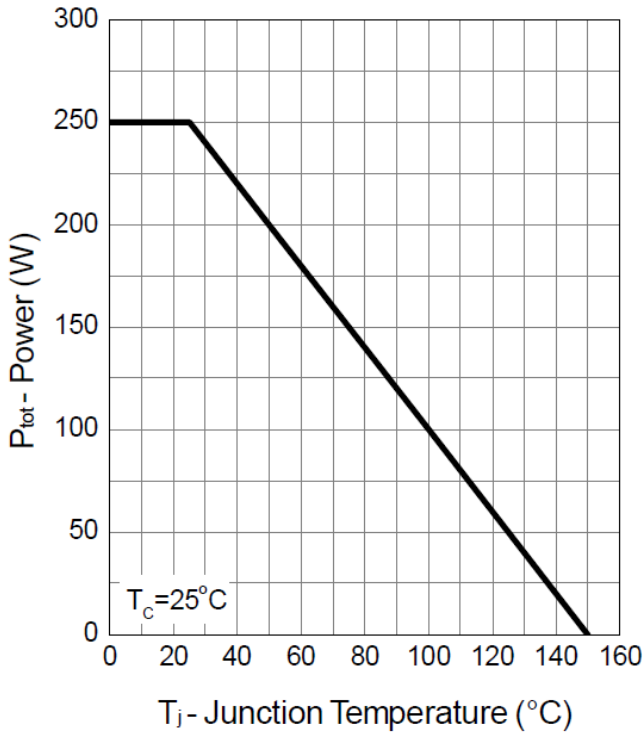
| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------|--|-----|------|-----------|------------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 150 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=120V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 30V, V_{DS}=0V$ | - | - | ± 100 | nA |
| ON CHARACTERISTICS (Note 2) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 3 | 4 | 5 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=40A$ | - | 11 | 13.5 | m Ω |
| DYNAMIC CHARACTERISTICS (Note 3) | | | | | | |
| Gate Resistance | R_G | $V_{DS}=0V, V_{GS}=0V, F=1.0MHz$ | - | 1.0 | - | Ω |
| Input Capacitance | C_{iss} | $V_{DS}=30V, V_{GS}=0V, F=1.0MHz$ | - | 5150 | 6700 | PF |
| Output Capacitance | C_{oss} | | - | 520 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 90 | - | PF |
| SWITCHING CHARACTERISTICS (Note 3) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DS}=30V, R_L=30\Omega, V_{GEN}=10V, R_G=6\Omega, I_D=1A$ | - | 32 | 58 | nS |
| Turn-on Rise Time | t_r | | - | 11 | 20 | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 68 | 123 | nS |
| Turn-Off Fall Time | t_f | | - | 47 | 85 | nS |
| Total Gate Charge | Q_g | $V_{DS}=30V, I_D=40A, V_{GS}=10V$ | - | 83 | 116 | nC |
| Gate-Source Charge | Q_{gs} | | - | 35 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 18 | - | nC |
| Body Diode Reverse Recovery Time | T_{rr} | $I_F=40A, di/dt=100A/\mu s$ | - | 75 | - | nS |
| Body Diode Reverse Recovery Charge | Q_{rr} | | - | 240 | - | nC |
| DRAIN-SOURCE DIODE CHARACTERISTICS | | | | | | |
| Diode Forward Voltage (Note 2) | V_{SD} | $V_{GS}=0V, I_S=20A$ | - | 0.8 | 1.3 | V |

NOTES:

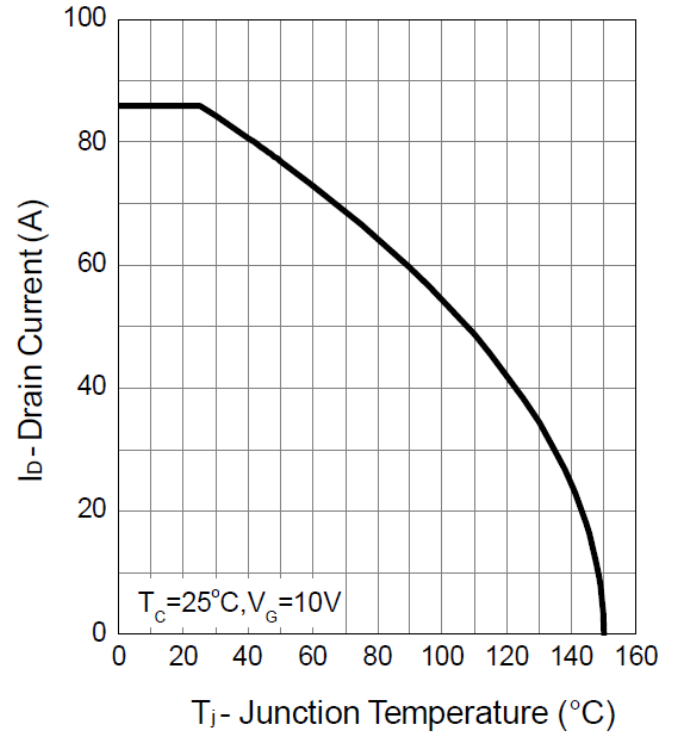
1. Pulse width limited by max. junction temperature.
2. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production testing

Typical Operating Characteristics

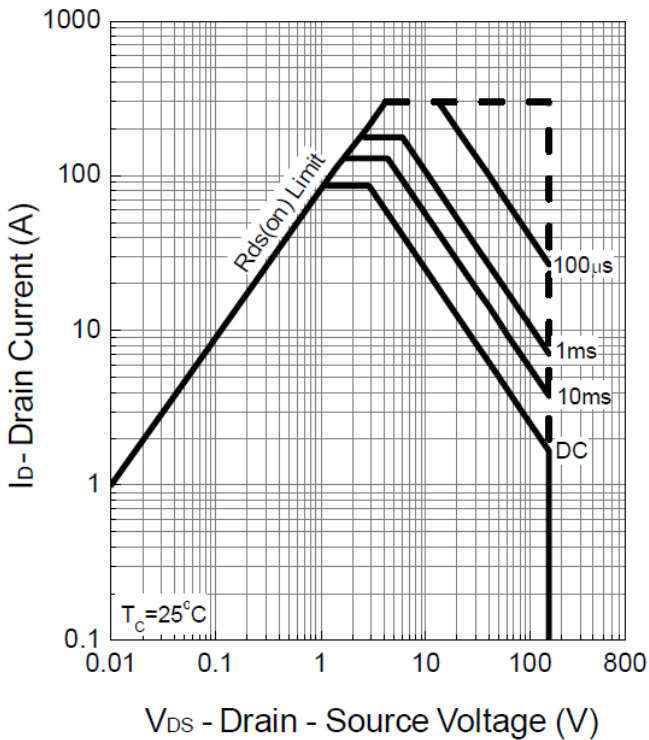
Power Dissipation



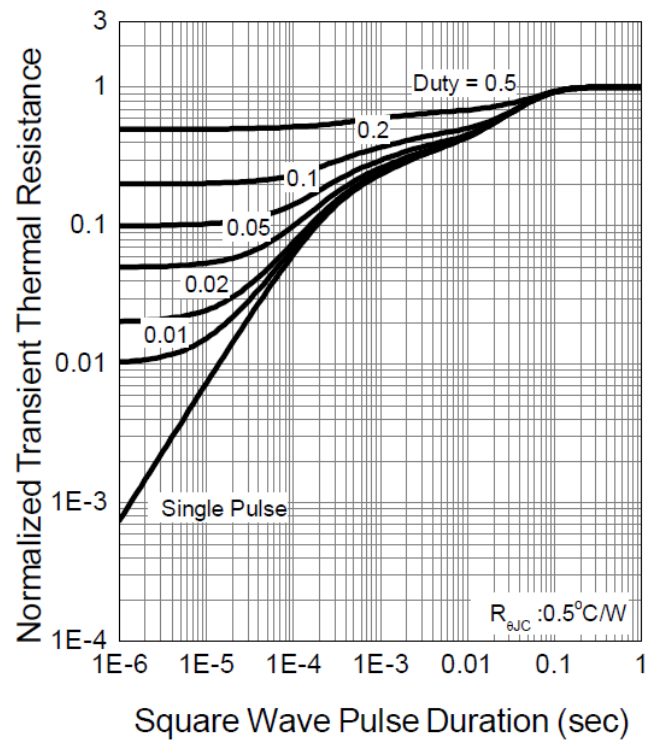
Drain Current



Safe Operation Area

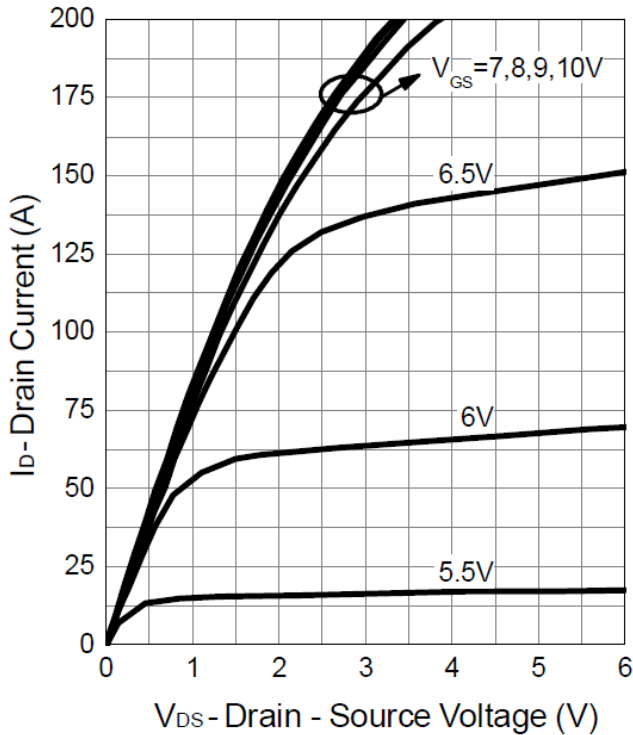


Thermal Transient Impedance

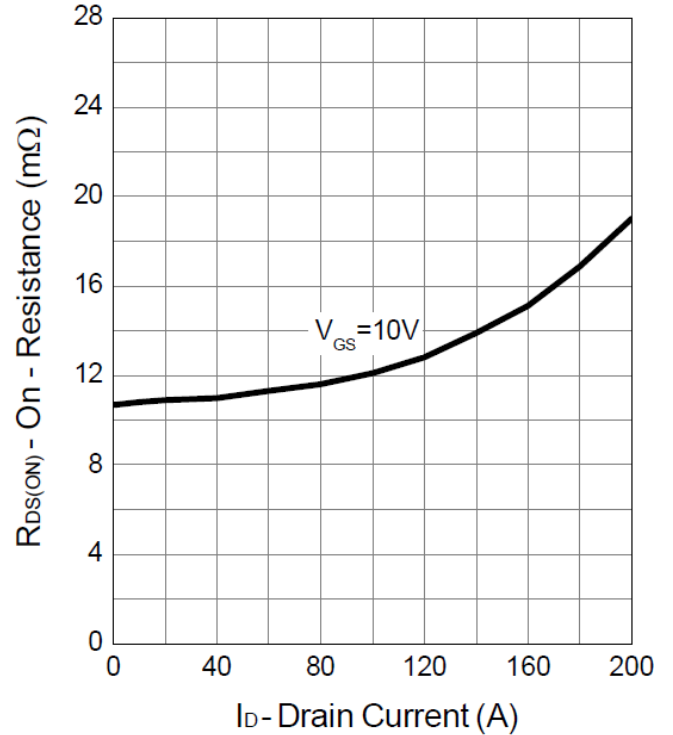


Typical Operating Characteristics (Cont.)

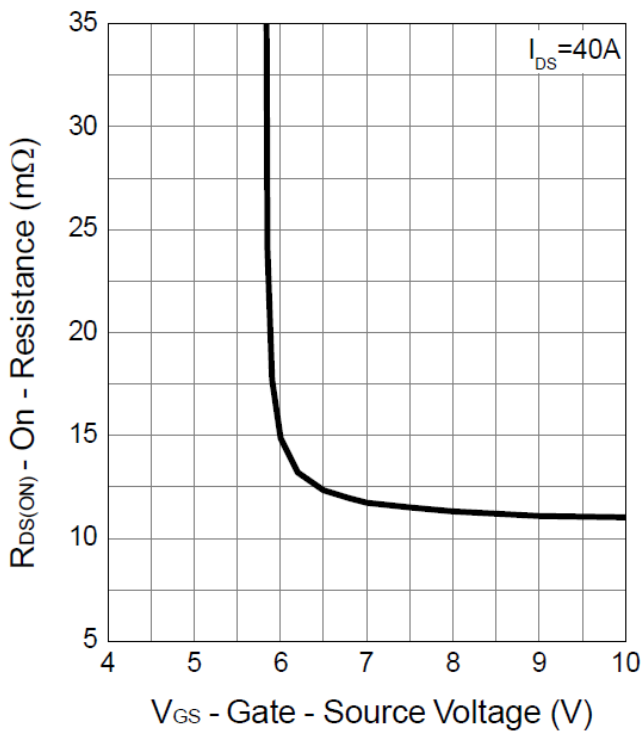
Output Characteristics



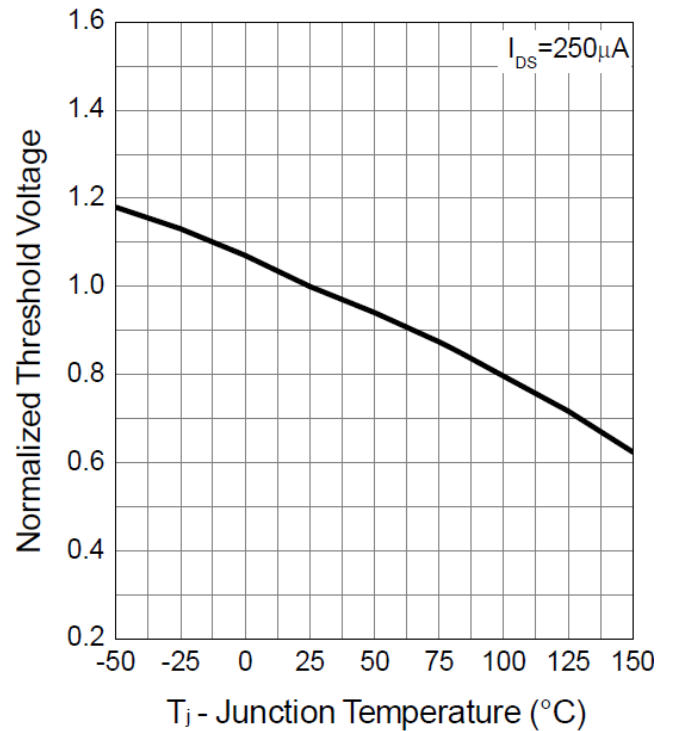
Drain-Source On Resistance



Gate-Source On Resistance

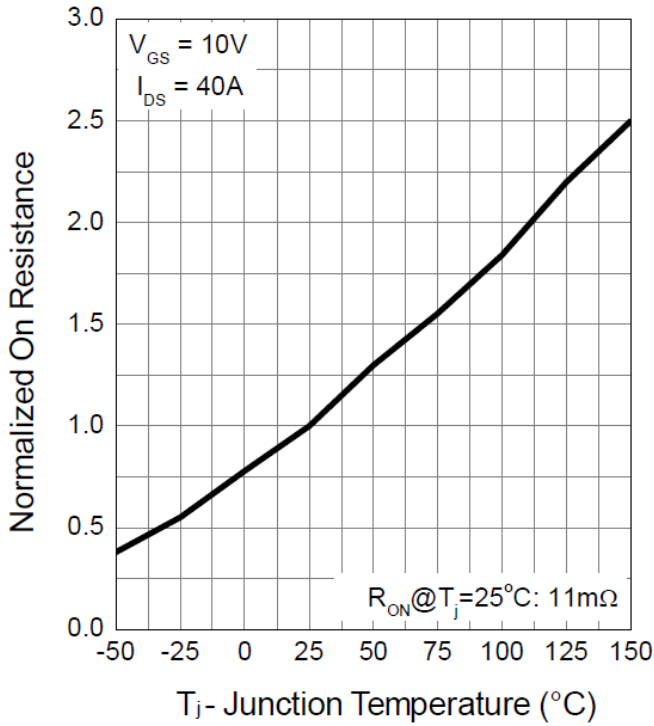


Gate Threshold Voltage

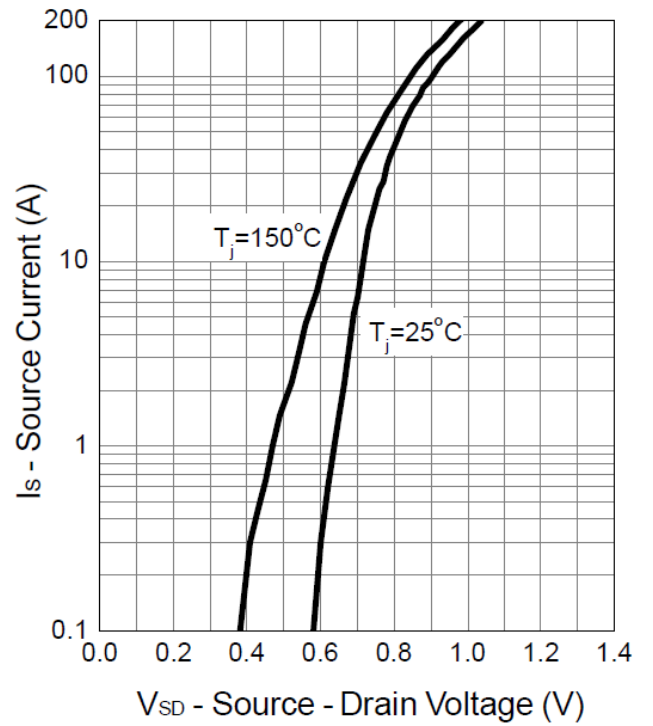


Typical Operating Characteristics (Cont.)

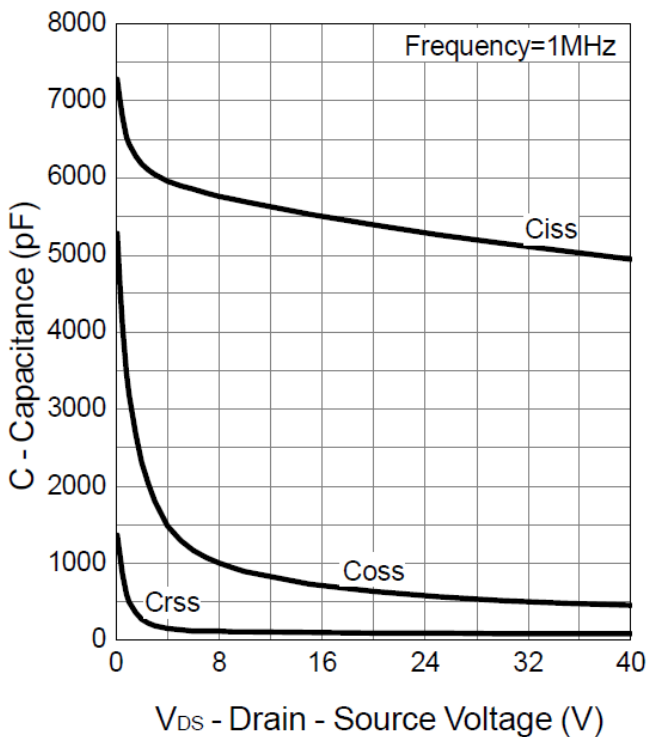
Drain-Source On Resistance



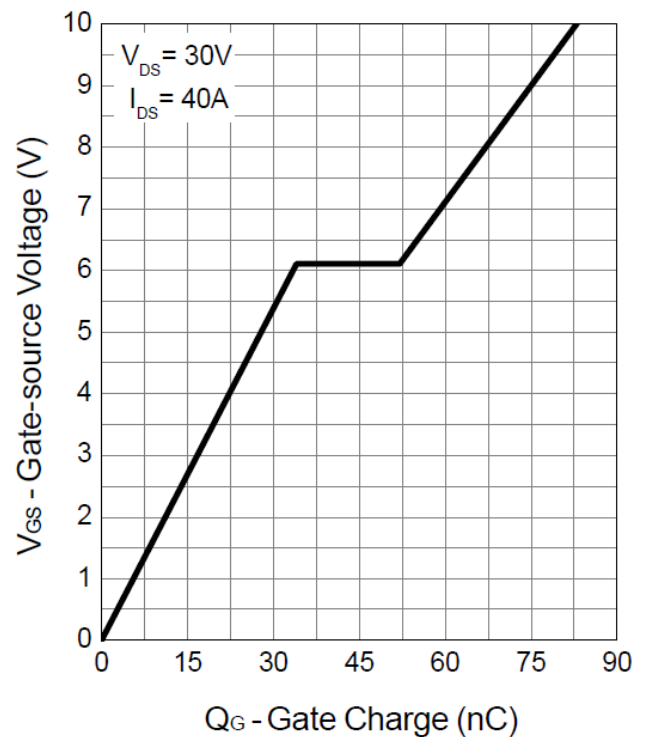
Source-Drain Diode Forward



Capacitance

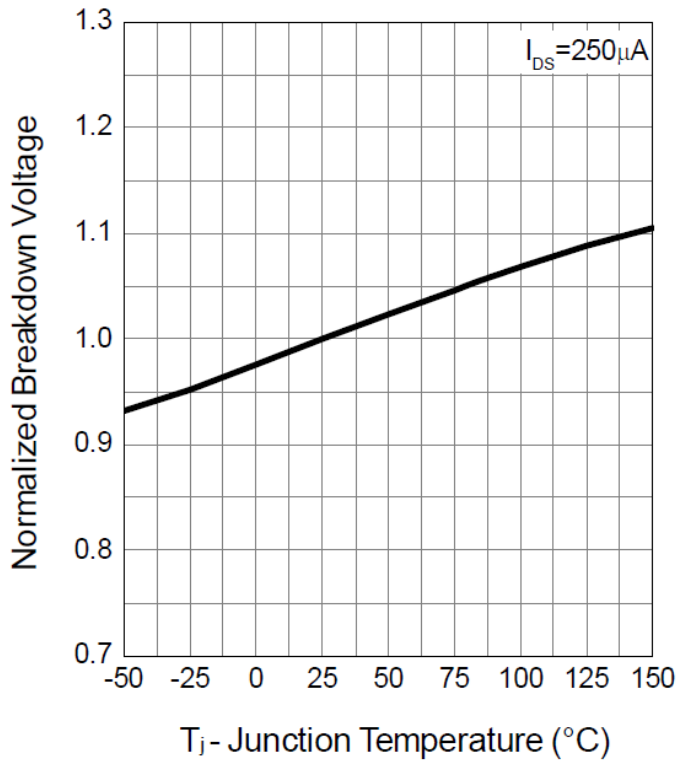


Gate Charge



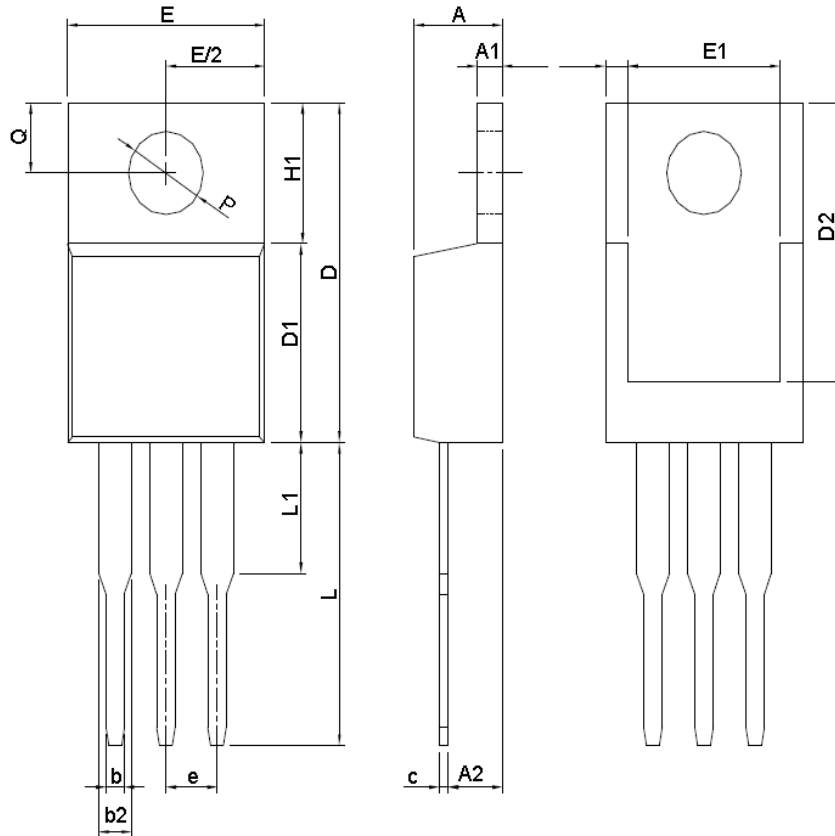
Typical Operating Characteristics (Cont.)

BVDSS vs Junction Temperature



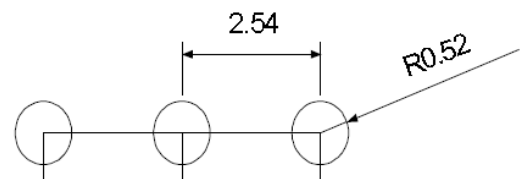
Package Information

TO220 Package



| SYMBOL | TO-220 | | | |
|--------|-------------|-------|-----------|-------|
| | MILLIMETERS | | INCHES | |
| | MIN. | MAX. | MIN. | MAX. |
| A | 3.56 | 4.83 | 0.140 | 0.190 |
| A1 | 0.51 | 1.40 | 0.020 | 0.055 |
| A2 | 2.03 | 2.92 | 0.080 | 0.115 |
| b | 0.38 | 1.02 | 0.015 | 0.040 |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 |
| c | 0.36 | 0.61 | 0.014 | 0.024 |
| D | 14.22 | 16.51 | 0.560 | 0.650 |
| D1 | 8.38 | 9.30 | 0.330 | 0.366 |
| D2 | 12.19 | 13.65 | 0.480 | 0.537 |
| E | 9.65 | 10.67 | 0.380 | 0.420 |
| E1 | 6.86 | 8.89 | 0.270 | 0.350 |
| e | 2.54 BSC | | 0.100 BSC | |
| H1 | 5.84 | 6.86 | 0.230 | 0.270 |
| L | 12.70 | 14.73 | 0.500 | 0.580 |
| L1 | - | 6.35 | - | 0.250 |
| P | 3.53 | 4.09 | 0.139 | 0.161 |
| Q | 2.54 | 3.43 | 0.100 | 0.135 |

RECOMMENDED LAND PATTERN



UNIT: mm

Design Notes